

BIRCH, STEWART, KOLASCH & BIRCH, LLP

P.O. Box 747 • Falls Church, Virginia 22040-0747
Telephone: (703) 205-8000 • Facsimile: (703) 205-8050

ATTORNEY DOCKET NO.

0171-1014P

PLEASE NOTE:
YOU MUST
COMPLETE THE
FOLLOWING:

COMBINED DECLARATION AND POWER OF ATTORNEY FOR PATENT AND DESIGN APPLICATIONS

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated next to my name; that I verily believe that I am the original, first and sole inventor (if only one inventor is named below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Insert Title:

Release Agent for Silicone Rubber Molding Molds and Molding Method

the specification of which is attached hereto. If not attached hereto,

Fill in Appropriate
Information -
For Use
Without
Specification
Attached:

the specification was filed on _____ as
United States Application Number _____;
and amended on _____ (if applicable); and/or
the specification was filed on _____ as PCT
International Application Number _____; and was
amended on _____ (if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representatives or assigns more than twelve months (six months for designs) prior to this application, and that no application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application by me or my legal representatives or assigns, except as follows.

I hereby claim foreign priority benefits under Title 35, United States Code, §119 (a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Insert Priority
Information:
(if appropriate)

Prior Foreign Application(s)

2002-244656 (Number)	Japan (Country)	08/26/2002 (Month / Day / Year Filed)	Priority Yes	Claimed No
_____ (Number)	_____ (Country)	_____ (Month / Day / Year Filed)	<input type="checkbox"/>	<input type="checkbox"/>
_____ (Number)	_____ (Country)	_____ (Month / Day / Year Filed)	<input type="checkbox"/>	<input type="checkbox"/>
_____ (Number)	_____ (Country)	_____ (Month / Day / Year Filed)	<input type="checkbox"/>	<input type="checkbox"/>

Insert Provisional
Application(s):
(if any)

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below.

_____ (Application Number)	_____ (Filing Date)
_____ (Application Number)	_____ (Filing Date)

All Foreign Applications, if any, for any Patent or Inventor's Certificate Filed more than 12 months (6 months for designs) Prior to the Filing Date of this Application:

Insert Requested
Information:
(if appropriate)

Country	Application Number	Date of Filing (Month / Day / Year)
_____	_____	_____
_____	_____	_____

Insert Prior U.S.
Application(s):
(if any)

_____ (Application Number)	_____ (Filing Date)	_____ (Status - patented, pending, abandoned)
_____ (Application Number)	_____ (Filing Date)	_____ (Status - patented, pending, abandoned)

I hereby appoint the practitioners at **CUSTOMER NO. 2292** as my attorneys or agents to prosecute this application and/or an international application based on this application and to transact all business in the Patent and Trademark Office connected therewith and in connection with the resulting patent based on instructions received from the entity who first sent the application papers to the practitioners, unless the inventor(s) or assignee provides said practitioners with a written notice to the contrary:

Send Correspondence to:

BIRCH, STEWART, KOLASCH & BIRCH, LLP or CUSTOMER NO. 2292
P.O. Box 747 • Falls Church, Virginia 22040-0747
Telephone: (703) 205-8000 • Facsimile: (703) 205-8050

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

PLEASE NOTE:
YOU MUST
COMPLETE THE
FOLLOWING:

Full Name of First or
Sole Inventor:
Insert Name of Inventor
Insert Date This
Document is Signed

Insert Residence
Insert Citizenship

Insert Mailing
Address

Full Name of Second
Inventor, if any:
see above

Full Name of Third
Inventor, if any:
see above

Full Name of Fourth
Inventor, if any:
see above

Full Name of Fifth
Inventor, if any:
see above

GIVEN NAME	FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Noriyuki	MEGURIYA	<i>Noriyuki Meguriya</i>	<i>Jul. 24th, 2003</i>
Residence (City, State & Country)		CITIZENSHIP	
Usui-gun, Gunma-ken, Japan		Japanese	
MAILING ADDRESS (Complete Street Address including City, State & Country) C/o Silicone-Electronics Materials Research Center, Shin-Etsu Chemical Co., Ltd., 1-10, Oaza Hitomi, Matsuida-machi, Usui-gun, Gunma-ken, Japan			
GIVEN NAME	FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Syuuichi	AZECHI	<i>Syuuichi Azechi</i>	<i>Jul. 24th, 2003</i>
Residence (City, State & Country)		CITIZENSHIP	
Usui-gun, Gunma-ken, Japan		Japanese	
MAILING ADDRESS (Complete Street Address including City, State & Country) C/o Silicone-Electronics Materials Research Center, Shin-Etsu Chemical Co., Ltd., 1-10, Oaza Hitomi, Matsuida-machi, Usui-gun, Gunma-ken, Japan			
GIVEN NAME	FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Naoki	YAMAKAWA	<i>Naoki Yamakawa</i>	<i>Jul. 24th, 2003</i>
Residence (City, State & Country)		CITIZENSHIP	
Usui-gun, Gunma-ken, Japan		Japanese	
MAILING ADDRESS (Complete Street Address including City, State & Country) C/o Silicone-Electronics Materials Research Center, Shin-Etsu Chemical Co., Ltd., 1-10, Oaza Hitomi, Matsuida-machi, Usui-gun, Gunma-ken, Japan			
GIVEN NAME	FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Makoto	KUSAMA	<i>Makoto Kusama</i>	<i>Jul. 24th, 2003</i>
Residence (City, State & Country)		CITIZENSHIP	
Chiyoda-ku, Tokyo, Japan		Japanese	
MAILING ADDRESS (Complete Street Address including City, State & Country) c/o Shin-Etsu Chemical Co., Ltd., 6-1, Otemachi, 2-chome, Chiyoda-ku, Tokyo, Japan			
GIVEN NAME	FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Residence (City, State & Country)		CITIZENSHIP	
MAILING ADDRESS (Complete Street Address including City, State & Country)			

* DATE OF SIGNATURE